

**• General Description**

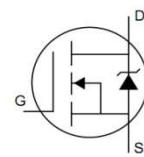
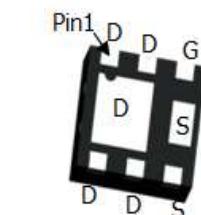
The ZM100N02L combines advanced trench MOSFET technology with a low resistance package to provide extremely low  $R_{DS(ON)}$ .

**• Features**

- Advance high cell density Trench technology
- Low  $R_{DS(ON)}$  to minimize conductive loss
- Low Gate Charge for fast switching
- Low Thermal resistance

**• Application**

- MB/VGA Vcore
- SMPS 2<sup>nd</sup> Synchronous Rectifier
- POL application
- BLDC Motor driver

**• Product Summary** $V_{DS} = 20V$  $R_{DS(ON)} = 11m\Omega$  $I_D = 18A$ 

DFN2\*2

**• Ordering Information:**

Part NO.	ZM100N02L
Marking	100N02
Packing Information	REEL TAPE
Basic ordering unit (pcs)	4000

**• Absolute Maximum Ratings ( $T_c = 25^\circ C$ )**

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	$V_{DS}$	20	V
Gate-Source Voltage	$V_{GS}$	$\pm 12$	V
Continuous Drain Current	$I_D @ T_c = 25^\circ C$	18	A
	$I_D @ T_c = 75^\circ C$	13.6	A
	$I_D @ T_c = 100^\circ C$	11.3	A
Pulsed Drain Current <sup>①</sup>	$I_{DM}$	46	A
Total Power Dissipation <sup>②</sup>	$P_D @ T_c = 25^\circ C$	10	W
Total Power Dissipation	$P_D @ T_A = 25^\circ C$	0.7	W
Operating Junction Temperature	$T_J$	-55 to 150	°C
Storage Temperature	$T_{STG}$	-55 to 150	°C

**•Thermal resistance**

Parameter	Symbol	Min.	Typ.	Max.	Unit
Thermal resistance, junction - case <sup>②</sup>	R <sub>thJC</sub>	-	-	13	° C/W
Thermal resistance, junction - ambient	R <sub>thJA</sub>	-	-	180	° C/W
Soldering temperature, wavesoldering for 10s	T <sub>sold</sub>	-	-	265	° C

**•Electronic Characteristics**

Parameter	Symbol	Condition	Min.	Typ	Max.	Unit
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =250uA	20			V
Gate Threshold Voltage	V <sub>GS(TH)</sub>	V <sub>GS</sub> =V <sub>DS</sub> , I <sub>D</sub> =250uA	0.5	0.8	1.2	V
Drain-Source Leakage Current	I <sub>DSS</sub>	V <sub>DS</sub> =20V, V <sub>GS</sub> =0V			1.0	uA
Gate- Source Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±12V, V <sub>DS</sub> =0V			±100	nA
Static Drain-source On Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =4.5V, I <sub>D</sub> =8A		11	14	mΩ
		V <sub>GS</sub> =2.5V, I <sub>D</sub> =6A		15	19	mΩ
Forward Transconductance	g <sub>FS</sub>	V <sub>DS</sub> =10V, I <sub>D</sub> =5A		8		s
Source-drain voltage	V <sub>SD</sub>	I <sub>S</sub> =8A			1.28	V

**•Electronic Characteristics**

Parameter	Symbol	Condition	Min.	Typ	Max.	Unit
Input capacitance	C <sub>iss</sub>	V <sub>DS</sub> =15V f = 1MHz	-	950	-	pF
Output capacitance	C <sub>oss</sub>		-	230	-	
Reverse transfer capacitance	C <sub>rss</sub>		-	100	-	

**•Gate Charge characteristics(T<sub>a</sub> = 25°C)**

Parameter	Symbol	Condition	Min.	Typ	Max.	Unit
Total gate charge	Q <sub>g</sub>	V <sub>DD</sub> =15V I <sub>D</sub> = 8A V <sub>GS</sub> = 10V	-	12	-	nC
Gate - Source charge	Q <sub>gs</sub>		-	2	-	
Gate - Drain charge	Q <sub>gd</sub>		-	4	-	

Note: ① Pulse Test : Pulse width ≤ 300μs, Duty cycle ≤ 2% ;

② Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate;



Fig.1 Gate-Charge Characteristics

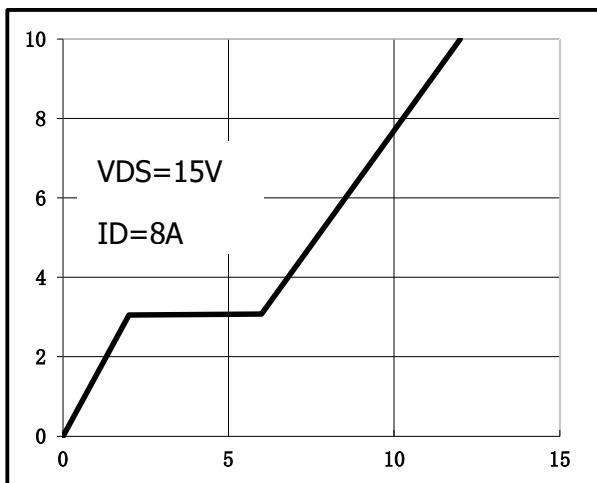


Fig.2 Capacitance Characteristics

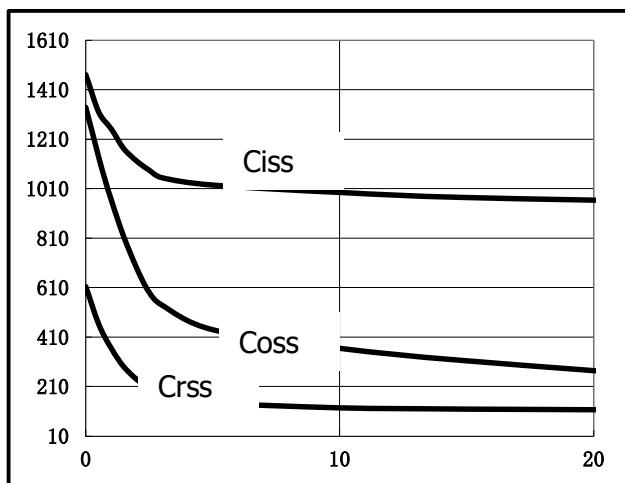


Fig.3 Power Dissipation Derating Curve

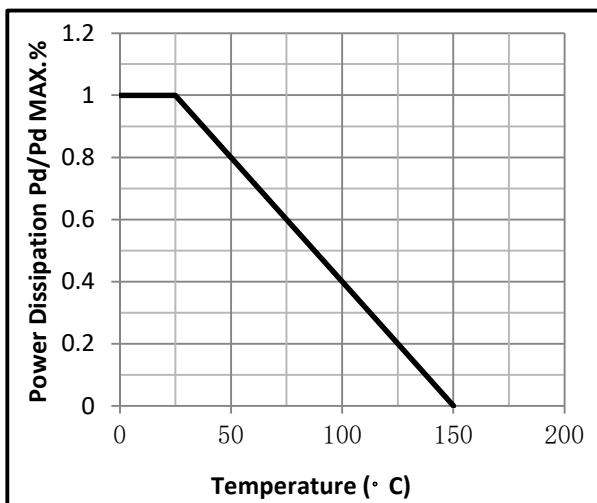


Fig.4 Typical output Characteristics

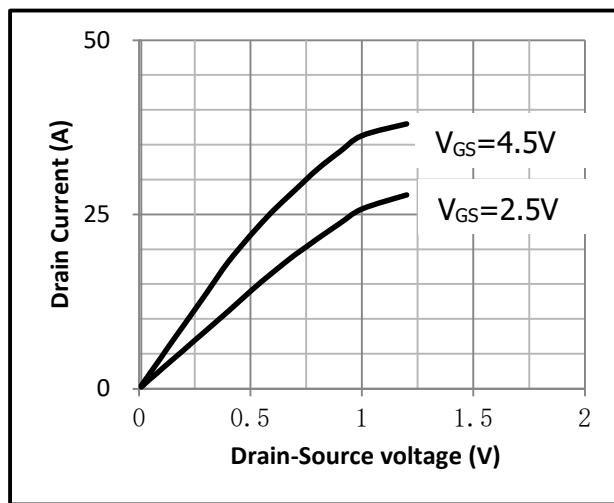


Fig.5 Threshold Voltage V.S Junction Temperature

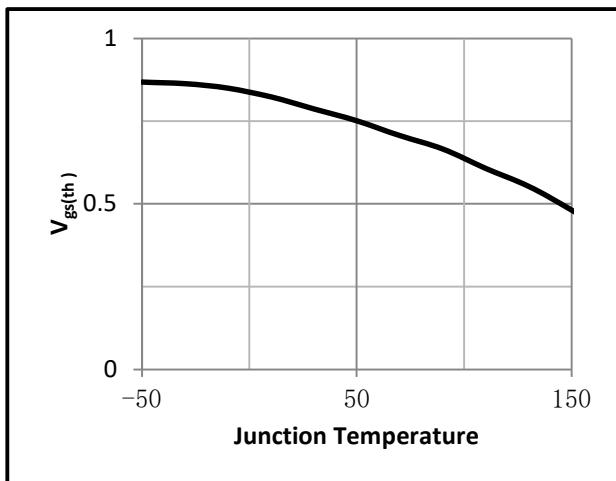


Fig.6 Resistance V.S Drain Current

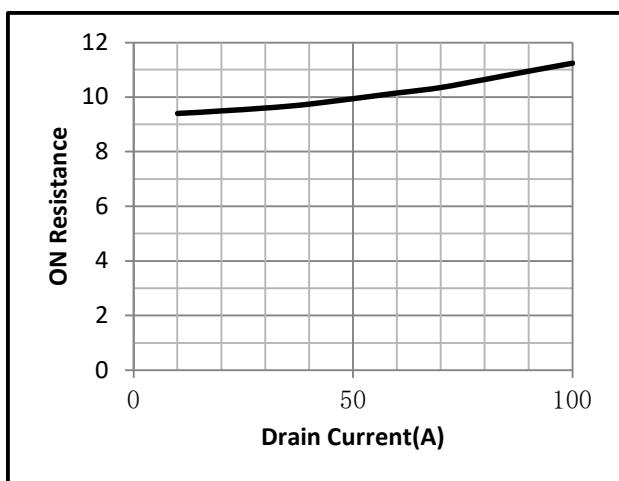




Fig.7 On-Resistance VS Gate Source Voltage

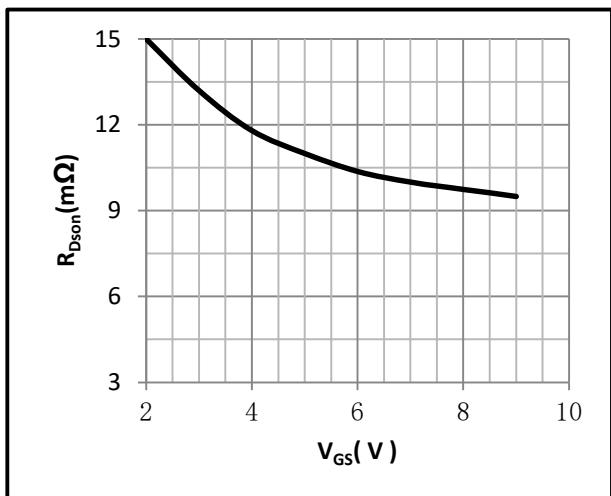


Fig.8 On-Resistance V.S Junction Temperature

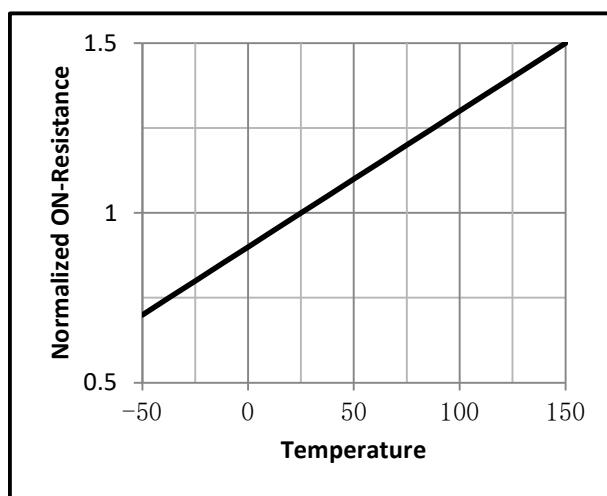


Fig.9 Switching Time Measurement Circuit

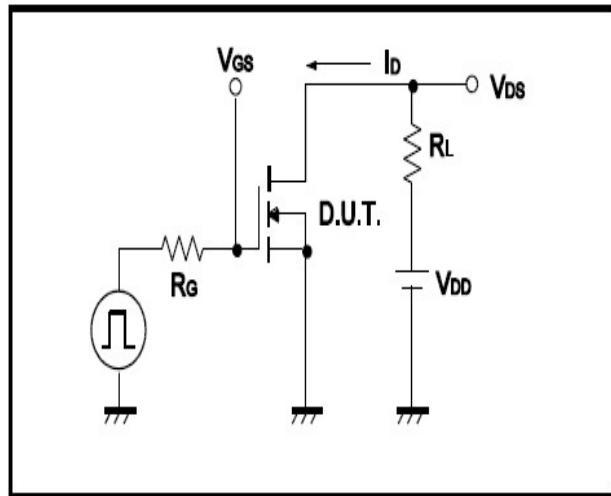


Fig.10 Gate Charge Waveform

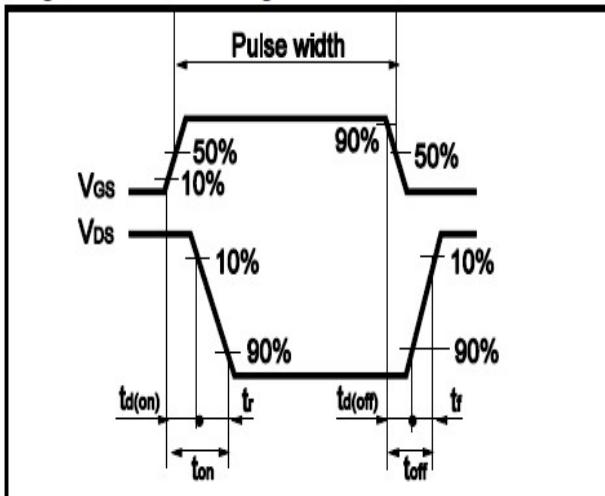


Fig.11 Avalanche Measurement Circuit

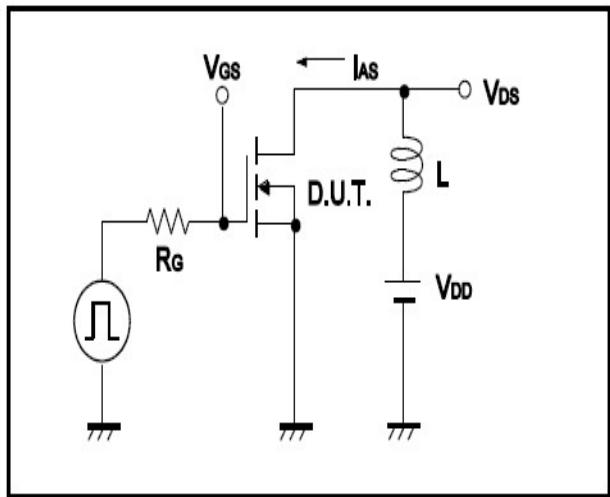
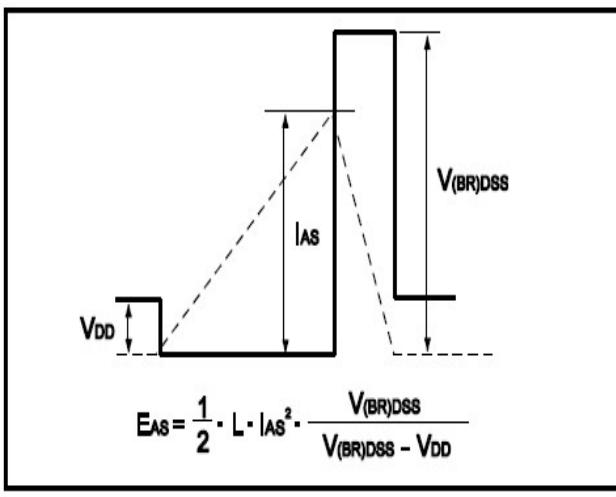
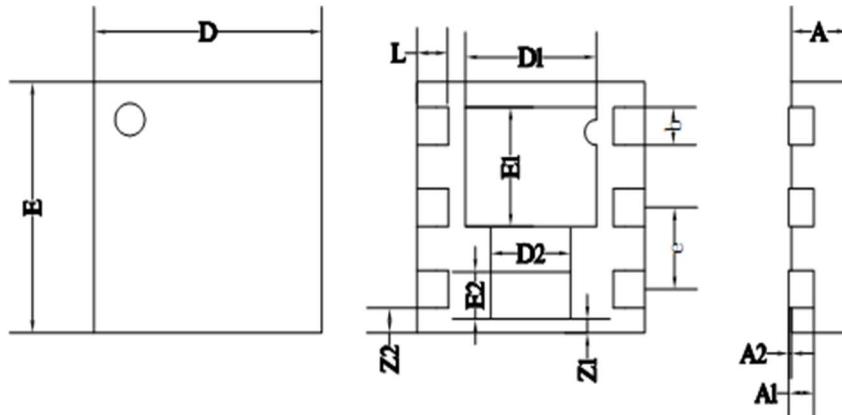


Fig.12 Avalanche Waveform



**• Dimensions (DFN2\*2)**

Unit: mm



NOTE:  
All dimensions are in mm

	MIN	NOM	MAX
D	1.95	2.00	2.05
E	1.95	2.00	2.05
D1	1.10	1.15	1.20
E1	0.90	0.95	1.00
D2	0.65	0.70	0.75
E2	0.33	0.38	0.43
L	0.225	0.275	0.325
b	0.25	0.30	0.35
e	0.65BSC		
A	0.45	0.50	0.55
A1	0.20REF		
A2	0.00	-	0.05
Z1	0.06	0.11	0.16
Z2	0.15	0.20	0.25